

Radiant heating plate with separate thermoregulation unit



Ref. PC500x400

The hotplate is mainly designed for circuit repair applications in SMT or traditional technology, glue drying etc. Very efficient for soldering with lead-free alloy with a very rapid temperature rise.

The heating plate allows CIE to be brought to temperature in complete safety:

- ✓ It is equipped with a thermal belt which prevents the transmission of heat to the bodywork, the operator can rest safely on the external edges during handling.
- ✓ The plate fairing allows, through a height adjustment system, to raise the card in relation to the surface of the heating plate
- ✓ The temperature remains displayed when the device is turned off and connected to the mains

Technical data						
Reference	Dimensions of the plate L x l mm	Overall Dimension L x l x H mm	Power / Mains supply	Regulation	Heating ramp	Maximal Temperature
PC3C	150 x 100	320 x 270 x 70	500 W / 230 V - 50/60 Hz	PID 2 displays	0 to 400°C / 30'	400°C
PC2C	150 x 200	320 x 270 x 70	1 500 W / 230 V - 50/60 Hz			
PC300x150C	150 x 300	420 x 270 x 70	1 500 W / 230 V - 50/60 Hz			
PCM450C	150 x 450	570 x 270 x 70	2 200 W / 230 V - 50/60 Hz			
PC300x200C	300 x 200	420 x 320 x 70	2 000 W / 230 V - 50/60 Hz			
PC1C	300 x 300	420 x 420 x 70	2 700 W / 230 V - 50/60 Hz			
PC300x350C	300 x 350	470 x 420 x 70	3 000 W / 230 V - 50/60 Hz			

This product does not require maintenance.

Available options : Magnetic PCB holder